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ABSTRACT OF THE DISCLOSURE

10 A copper-clad laminate is composed of a polyimide  
film and an electrolytically plated copper film placed on  
at least one surface side of the polyimide film, in which  
the copper film has at most 200 protrusions having a  
diameter of 15  $\mu\text{m}$  or more on its surface not facing the  
polyimide film, and the laminate has a peel strength of 1  
kgf/cm or more and shows a peel strength of 0.6 kgf/cm or  
15 more after heating at 150°C for 24 hours.